

# Product / Process Change Notification



N° 2020-094-A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

## **Change of Wafer Production and Wafer Test Location from Infineon Technologies Austria AG, Villach, Austria to Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia for Products BTT6030-2ExA and BTT6100-2ExA**

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **10. September 2020**.
- Infineon aligns with the widely-recognized JEDEC STANDARD “**JESD46**“, which stipulates:  
“**Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.**”

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG  
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Chairman of the Supervisory Board: Dr. Wolfgang Eder  
Management Board: Dr. Reinhard Ploss (CEO), Dr. Helmut Gassel, Jochen Hanebeck, Dr. Sven Schneider  
Registered Office: Neubiberg  
Commercial Register: München HRB 126492

# Product / Process Change Notification



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► **Products affected:** Please refer to attached affected product list 1\_cip20094\_A

► **Detailed Change Information:**

**Subject:** Change of Wafer Production and Wafer Test Location from Infineon Technologies Austria AG, Villach, Austria to Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia for Products BTT6030-2ExA and BTT6100-2ExA

**Reason:** The wafer production and wafer test location of the affected products will be transferred to location Kulim, Malaysia according to the global Infineon production strategy.

<b>Description:</b>	<b><u>Old</u></b>	<b><u>New</u></b>
<b>Wafer production and test location</b>	■ Infineon Technologies Austria AG, Villach, Austria	■ Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia

► **Product Identification:** Wafer lot numbers from Villach start with VExxxxxx.  
Wafer lot numbers from Kulim with 1Exxxxxx  
Traceability assured via date code  
No change in SP ordering number

► **Impact of Change:** Based on the qualification performed, Infineon does not expect any negative impact on quality, function and reliability. No change in fit, form and function expected.  
DeQuMa-IDs: SEM-PW-13 / SEM-TF-01

► **Attachments:** 1\_cip20094\_A affected product list

► **Time Schedule:**

- |                               |   |
|-------------------------------|---|
| ■ Final qualification report: | available   |
| ■ First samples available:    | on request  |
| ■ Intended start of delivery: | 08-February-2021 or earlier after customer approval |

If you have any questions, please do not hesitate to contact your local Sales office.

**PCN N° 2019-094-A**

Change of Wafer Production and Wafer Test Location from Infineon Technologies Austria AG,  
Villach, Austria to Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia for Products  
BTT6030-2ExA and BTT6100-2ExA



<b>Sales name</b>	<b>SP number</b>	<b>OPN</b>	<b>Package</b>
BTT6030-2EKA	SP001004946	BTT60302EKAXUMA1	PG-DSO-14-40
BTT6030-2ERA	SP001682656	BTT60302ERAXUMA1	PG-TDSO-14-31
BTT6100-2EKA	SP001070124	BTT61002EKAXUMA1	PG-DSO-14-40
BTT6100-2ERA	SP001682672	BTT61002ERAXUMA1	PG-TDSO-14-21